# 6A, Power Module Buck Converter with HyperLight Load ${ }^{\circledR}$ and $I^{2} \mathrm{C}$ Interface 

## Features

- Input Voltage Range: 2.4 V to 5.5 V
- 6A Output Current
- Multiple Faults Indication through $I^{2} \mathrm{C}$
- $\mathrm{I}^{2} \mathrm{C}$ Programmable:
- Output voltage: $0.6 \mathrm{~V}-1.28 \mathrm{~V}, 5 \mathrm{mV}$ resolution; $0.6 \mathrm{~V}-3.84 \mathrm{~V}, 10 / 20 \mathrm{mV}$ resolution
- Slew rate: $0.2 \mathrm{~ms} / \mathrm{V}-3.2 \mathrm{~ms} / \mathrm{V}$
- On time (switching frequency)
- High-side current limit: 3.5A-10A
- Enable delay: $0.2 \mathrm{~ms}-3 \mathrm{~ms}$
- Output discharge when disabled (EN = GND)
- High Efficiency (up to 95\%)
- Ultra-Fast Transient Response
- $\pm 1.5 \%$ Output Voltage Accuracy Over Line/Load/Temperature Range
- Safe Start-up with Pre-Biased Output
- Typical $1.5 \mu \mathrm{~A}$ Shutdown Supply Current
- Low Dropout (100\% Duty Cycle) Operation
- $\mathrm{I}^{2} \mathrm{C}$ Speed, Up to 3.4 MHz
- Latch-Off Thermal Shutdown Protection
- Latch-Off Current Limit Protection
- Meets CISPR32 Class B Emissions
- Power Good (PG) Open-Drain Output
- Package: 53-Lead, $6 \mathrm{~mm} \times 10 \mathrm{~mm}$ B1QFN


## Applications

- Solid-State Drives (SSD)
- FPGAs, DSP and Low-Voltage ASIC Power


## General Description

The Microchip MIC33M656 is an $I^{2} \mathrm{C}$ programmable, high-efficiency, low-voltage input, 6A current, synchronous step-down regulator power module with integrated inductor. The Constant-On-Time (COT) control architecture with HyperLight Load ${ }^{\circledR}$ mode provides very high efficiency at light loads, while still having ultra-fast transient response.

The $1^{2} \mathrm{C}$ interface allows programming the output voltage, between 0.6 V and 1.28 V with 5 mV resolution, or between 0.6 V and 3.84 V with 10 mV and 20 mV resolution. Three different default voltage options $(0.6 \mathrm{~V}, 0.9 \mathrm{~V}$ and 1.0 V$)$ are provided so that the application can be started with a safe voltage level and then moved to high-performance modes under $I^{2} \mathrm{C}$ control.
An open-drain Power Good output facilitates output voltage monitoring and sequencing. If set in shutdown (EN = GND), the MIC33M656 typically draws $1.5 \mu \mathrm{~A}$, while the output is discharged through a $10 \Omega$ pull-down (if the output discharge feature is enabled).
The MIC33M656 pinout is compatible with the MIC33M650, so that applications can be easily converted.
The 2.4 V to 5.5 V input voltage range, low shutdown and quiescent currents make the MIC33M656 ideal for single-cell Li-ion battery-powered applications. The 100\% duty cycle capability provides low dropout operation, extending operating range in portable systems.
The MIC33M656 is available in a thermally efficient, 53-Lead, $6 \mathrm{~mm} \times 10 \mathrm{~mm} \times 3 \mathrm{~mm}$ B1QFN package, with an operating junction temperature range from $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$.


FIGURE 1: Radiated Emissions, CISPR32, Class B ( $V_{I N}=5 \mathrm{~V}, V_{O U T}=1 \mathrm{~V}$, $I_{\text {OUT }}=6 A$ ).

## Package Types



## Typical Application



## Ordering Information

| Part Number | Default Status at Power-up |  |  |  |  |  | Output Voltage <br> Range/Step |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Output <br> Voltage | High-Side <br> Curent Limit <br> (typical) | TON[1:0] <br> (ns) | Soft Start <br> Speed | Overtemp <br> Latch-Off | Output <br> Pull-Down When <br> Disabled |  |
| MIC33M656-HAYMP | 1.0 V | 10 A | $[10]-130 \mathrm{~ns}$ | $800 \mu \mathrm{~s} / \mathrm{V}$ | Latch-Off after <br> 4 OT Cycles | Yes | $0.600 \mathrm{~V}-1.280 \mathrm{~V} / 5 \mathrm{mV}$ |
| MIC33M656-FAYMP | 0.9 V | 10 A | $[10]-130 \mathrm{~ns}$ | $800 \mu \mathrm{~s} / \mathrm{V}$ | Latch-Off after <br> 4 OT Cycles | Yes | $0.600 \mathrm{~V}-1.280 \mathrm{~V} / 5 \mathrm{mV}$ |
| MIC33M656-SAYMP | 1.0 V | 10 A | $[10]-130 \mathrm{~ns}$ | $800 \mu \mathrm{~s} / \mathrm{V}$ | Latch-Off after <br> 4 OT Cycles | Yes | $0.600 \mathrm{~V}-1.280 \mathrm{~V} / 10 \mathrm{mV}$ <br> $1.280 \mathrm{~V}-3.840 \mathrm{~V} / 20 \mathrm{mV}$ |

Functional Block Diagram


## MIC33M656

NOTES:

### 1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings $\dagger$
$\mathrm{SV}_{\mathrm{IN}}, \mathrm{PV}_{\text {IN }}$ to $\mathrm{A}_{\mathrm{GND}}$.................................................................................................................................. -0.3V to +6 V
$V_{S W}$ to $A_{G N D}$ ..... -0.3 V to +6 V
$V_{\text {EN }}$ to $A_{\text {GND }}$ ..... -0.3 V to $\mathrm{PV}_{\mathrm{IN}}$
$V_{\mathrm{PG}}$ to $\mathrm{A}_{\mathrm{GND}}$ ..... -0.3 V to $\mathrm{PV}_{\text {IN }}$
$V_{S D A}, V_{S C L}$ to $A_{G N D}$ ..... -0.3 V to $\mathrm{PV}_{\text {IN }}$
$\mathrm{PV}_{\text {IN }}$ to $\mathrm{SV}_{\text {IN }}$ ..... -0.3 V to +0.3 V
$A_{G N D}$ to $P_{G N D}$ ..... -0.3 V to +0.3 V
Junction Temperature ..... $+150^{\circ} \mathrm{C}$
Storage Temperature ( $\mathrm{T}_{\mathrm{S}}$ ) ..... $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Lead Temperature (soldering, 10s) ..... $+260^{\circ} \mathrm{C}$
ESD Rating (Note 1)
HBM ..... 2000V
CDM ..... 1500 V
$\dagger$ Notice: Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.
Note 1: Devices are ESD-sensitive. Handling precautions recommended. Human body model, $1.5 \mathrm{k} \Omega$ in series with100 pF .
Operating Ratings ${ }^{(1)}$
Supply Voltage ( $\mathrm{PV}_{\mathrm{IN}}$ ) ..... 2.4 V to 5.5 V
Enable Voltage ( $\mathrm{V}_{\mathrm{EN}}$ ) ..... 0 V to $\mathrm{PV} \mathrm{I}_{\mathrm{IN}}$
Power Good (PG) Pull-up Voltage ( $\mathrm{V}_{\mathrm{PU} \text { _PG }}$ ) ..... 0 V to 5.5 V
$A U X \_P V_{I N}$ to $P V_{I N}$ 0 V (shorted in operation)
AUX_A ${ }_{G N D}$ to $A_{G N D}$ ..... OV (shorted in operation)
Maximum Output Current. ..... 6A
Junction Temperature ( $\mathrm{T}_{\mathrm{J}}$ ) ..... $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$

Note 1: The device is not ensured to function outside the operating range.

## ELECTRICAL CHARACTERISTICS ${ }^{(1,2)}$

Electrical Specifications: Unless otherwise specified, $\mathrm{PV}_{\mathrm{IN}}=5 \mathrm{~V} ; \mathrm{V}_{\mathrm{OUT}}=1.0 \mathrm{~V} ; \mathrm{C}_{\mathrm{OUT}}=2 \times 47 \mu \mathrm{~F} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Boldface values indicate $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{J}} \leq+125^{\circ} \mathrm{C}$.

| Parameter | Symbol | Min. | Typ. | Max. | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathbf{V}_{\text {IN }}$ Supply |  |  |  |  |  |  |
| Input Range | PV IN | 2.4 | - | 5.5 | V |  |
| Undervoltage Lockout Threshold | UVLO | 2.15 | 2.225 | 2.35 | V | SV ${ }_{\text {IN }}$ rising |
| Undervoltage Lockout Hysteresis | UVLO_H | - | 153 | - | V | SV ${ }_{\text {IN }}$ falling |
| Operating Supply Current | $\mathrm{I}_{\text {INO }}$ | - | 60 | 100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{FB}}=1.2 \mathrm{~V}$, non-switching |
| Shutdown Current | $\mathrm{I}_{\text {SHDN }}$ | - | 1.5 | 10 | $\mu \mathrm{A}$ | $\begin{aligned} & \mathrm{V}_{E N}=0 \mathrm{~V}, P V_{I N}=S V_{I N}=5.5 \mathrm{~V}, \\ & V_{S W}=V_{S D A}=V_{S C L}=0 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq T_{J} \leq+105^{\circ} \mathrm{C} \end{aligned}$ |
|  |  |  |  | 20 | $\mu \mathrm{A}$ | $\begin{aligned} & V_{E N}=0 V, P V_{I N}=S V_{I N}=5.5 \mathrm{~V}, \\ & V_{S W}=V_{S D A}=V_{S C L}=0 \mathrm{~V}, \\ & -40^{\circ} \mathrm{C} \leq T_{J} \leq+125^{\circ} \mathrm{C} \end{aligned}$ |
| Output Voltage |  |  |  |  |  |  |
| Output Accuracy | V ${ }_{\text {OUT_ACC }}$ | -1.5 | - | 1.5 | \% | $\mathrm{V}_{\text {Out }}$ from 0.6 V to 1.28 V (includes line and load regulation) |
| Output Voltage Step (options HAYMP, FAYMP) | V ${ }_{\text {OUT_STEP }}$ | - | 5 | - | mV | $\mathrm{V}_{\text {OUT }}$ from 0.6 V to 1.28 V |
| Output Voltage Step (option SAYMP) | Vout_StEP | - | 10 | - | mV | $\mathrm{V}_{\text {OUT }}$ from 0.6 V to 1.28 V |
|  |  | - | 20 | - |  | $\mathrm{V}_{\text {OUT }}$ from 1.28 V to 3.84 V |
| Line Regulation |  | - | 0.06 | - | \% | $\begin{aligned} & \mathrm{V}_{\text {OUT }}=1.0 \mathrm{~V}, \mathrm{~V}_{\text {IN }}=2.5 \text { to } 5.5 \mathrm{~V}, \\ & \mathrm{I}_{\text {OUT }}=300 \mathrm{~mA} \end{aligned}$ |
| Load Regulation |  | - | 0.2 | - | \% | $\mathrm{V}_{\text {OUT }}=1.0 \mathrm{~V}, \mathrm{I}_{\text {OUT }}=0 \mathrm{~A}$ to 6 A |
| Enable Control |  |  |  |  |  |  |
| EN Logic Level High | $\mathrm{V}_{\text {EN_H }}$ | 1.2 | - | - | V | $\mathrm{V}_{\text {EN }}$ Rising, regulator enabled |
| EN Logic Level Low | $\mathrm{V}_{\text {EN_L }}$ | - | - | 0.4 | V | $V_{\text {EN }}$ falling, regulator shutdown |
| EN Low Input Current | $\mathrm{I}_{\text {EN_L }}$ | - | 0.01 | 500 | nA | $\mathrm{V}_{\mathrm{EN}}=0 \mathrm{~V}$ |
| EN High Input Current | $\mathrm{IEN}_{\text {- }}$ | - | 0.01 | 500 | nA | $\mathrm{V}_{\text {EN }}=5.5 \mathrm{~V}$ |
| Enable Delay (Two Bits) |  |  |  |  |  |  |
| Enable Lockout Delay |  | 0.15 | 0.25 | 0.4 | ms | EN_DELAY[1:0] = 00, default |
|  |  | 0.85 | 1 | 1.20 | ms | EN_DELAY[1:0] = 01 |
|  |  | 1.70 | 2 | 2.35 | ms | EN_DELAY[1:0] = 10 |
|  |  | 2.55 | 3 | 3.5 | ms | EN_DELAY[1:0] = 11 |

Note 1: Specification for packaged product only.
2: Characterized in open loop.

## ELECTRICAL CHARACTERISTICS ${ }^{(1,2)}$ (CONTINUED)

Electrical Specifications: Unless otherwise specified, $\mathrm{PV}_{\mathrm{IN}}=5 \mathrm{~V} ; \mathrm{V}_{\text {OUT }}=1.0 \mathrm{~V} ; \mathrm{C}_{\mathrm{OUT}}=2 \times 47 \mu \mathrm{~F} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Boldface values indicate $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{J}} \leq+125^{\circ} \mathrm{C}$.

| Parameter | Symbol | Min. | Typ. | Max. | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Internal DAC Slew Rate (Four Bits) |  |  |  |  |  |  |
| Slew Rate Time (time to 1V) | $\mathrm{T}_{\text {RISE }}$ | 100 | 200 | 300 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 0000 |
|  |  | 250 | 400 | 550 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 0001 |
|  |  | 400 | 600 | 800 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 0010 |
|  |  | 600 | 800 | 1000 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 0011, default |
|  |  | 750 | 1000 | 1250 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 0100 |
|  |  | 950 | 1200 | 1450 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 0101 |
|  |  | 1100 | 1400 | 1700 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 0110 |
|  |  | 1300 | 1600 | 1900 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 0111 |
|  |  | 1450 | 1800 | 2150 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 1000 |
|  |  | 1650 | 2000 | 2350 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 1001 |
|  |  | 1800 | 2200 | 2600 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 1010 |
|  |  | 2000 | 2400 | 2800 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 1011 |
|  |  | 2180 | 2600 | 3020 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 1100 |
|  |  | 2350 | 2800 | 3250 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 1101 |
|  |  | 2520 | 3000 | 3480 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 1110 |
|  |  | 2690 | 3200 | 3710 | $\mu \mathrm{s} / \mathrm{V}$ | SLEW_RATE[3:0] = 1111 |
| TON Control/Switching Frequency (Two Bits) |  |  |  |  |  |  |
| Switching On Time | $\mathrm{T}_{\mathrm{ON}}$ | - | 260 | - | ns | $\mathrm{V}_{\text {OUT }}=1 \mathrm{~V}, \mathrm{TON}[1: 0]=00$ |
|  |  | - | 180 | - |  | $\mathrm{V}_{\text {OUT }}=1 \mathrm{~V}, \mathrm{TON}[1: 0]=01$ |
|  |  | - | 130 | - |  | $\mathrm{V}_{\text {OUT }}=1 \mathrm{~V}, \mathrm{TON}[1: 0]=10$ |
|  |  | - | 105 | - |  | $\mathrm{V}_{\text {OUT }}=1 \mathrm{~V}, \mathrm{TON}[1: 0]=11$ |
| Switching Frequency | FREQ | - | 1.6 | - | MHz | $\begin{aligned} & \mathrm{V}_{\text {OUT }}=1 \mathrm{~V}, \operatorname{TON}[1: 0]=10, \\ & \mathrm{l}_{\text {OUT }}=3 \mathrm{~A} \end{aligned}$ |
|  |  | - | 2.2 | - | MHz | $\begin{aligned} & \mathrm{V}_{\text {OUT }}=3.3 \mathrm{~V}, \operatorname{TON}[1: 0]=10, \\ & \mathrm{l}_{\text {OUT }}=3 \mathrm{~A} \end{aligned}$ |
| Maximum Duty Cycle | DCMAX | - | 100 | - | \% |  |

Note 1: Specification for packaged product only.
2: Characterized in open loop.

## ELECTRICAL CHARACTERISTICS ${ }^{(1,2)}$ (CONTINUED)

Electrical Specifications: Unless otherwise specified, $P V_{I N}=5 \mathrm{~V} ; \mathrm{V}_{\mathrm{OUT}}=1.0 \mathrm{~V} ; \mathrm{C}_{\mathrm{OUT}}=2 \times 47 \mu \mathrm{~F} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Boldface values indicate $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{J}} \leq+125^{\circ} \mathrm{C}$.

| Parameter | Symbol | Min. | Typ. | Max. | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Short-Circuit Protection |  |  |  |  |  |  |
| High-Side MOSFET Forward Current Limit | ILIM_HS | 2.1 | 3.5 | 4.9 | A | ILIM[1:0] = 00 |
|  |  | 4.0 | 5.0 | 6.5 |  | ILIM[1:0] = 01 |
|  |  | 6.4 | 8.5 | 10.6 |  | ILIM[1:0] = 10 |
|  |  | 8.0 | 10.0 | 12.0 |  | ILIM[1:0] = 11, default |
| Low-Side MOSFET Forward Current Limit | ILIM_LS | - | 3.0 | - | A | ILIM[1:0] = 00 |
|  |  | - | 4.2 | - |  | ILIM[1:0] = 01 |
|  |  | - | 6.8 | - |  | ILIM[1:0] = 10 |
|  |  | - | 8.0 | - |  | ILIM[1:0] = 11, default |
| Low-Side MOSFET Negative Current Limit | ILIM_NEG | -2 | -3 | -4 | A |  |
| N-Channel Zero-Crossing Threshold | $\mathrm{I}_{\text {ZC_TH }}$ | - | 0.9 | - | A |  |
| Current Limit Pulses before Hiccup | HICCUP | - | 8 | - | Cycles |  |
| Hiccup Period before Restart | - | - | 1 | - | ms |  |
| Internal MOSFETs |  |  |  |  |  |  |
| High-Side On-Resistance | $\mathrm{R}_{\text {DS-ON-HS }}$ | - | 30 | 60 | $\mathrm{m} \Omega$ | $\mathrm{I}_{\text {SW }}=1 \mathrm{~A}$ |
| Low-Side On-Resistance | $\mathrm{R}_{\text {DS-ON-LS }}$ | - | 16 | 40 | $\mathrm{m} \Omega$ | $\mathrm{I}_{\text {SW }}=-1 \mathrm{~A}$ |
| Output Discharge Resistance | R ${ }_{\text {DS-ON-DSC }}$ | - | 10 | 50 | $\Omega$ | $\begin{aligned} & \mathrm{V}_{\mathrm{EN}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{SW}}=5.5 \mathrm{~V}, \\ & \text { from } \mathrm{V}_{\mathrm{OUT}} \text { to } \mathrm{P}_{\mathrm{GND}} \\ & \hline \end{aligned}$ |
| SW Leakage Current | ILEAK_SW | - | 1 | 10 | $\mu \mathrm{A}$ | $\mathrm{PV}_{\mathrm{IN}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{SW}}=5.5 \mathrm{~V}, \mathrm{~V}_{\mathrm{EN}}=0 \mathrm{~V}$ |
| Power Good (PG) |  |  |  |  |  |  |
| PG Threshold | PG_TH | 87 | 91 | 95 | \% $\mathrm{V}_{\text {OUT }}$ | $\mathrm{V}_{\text {OUT }}$ rising (good) |
| PG Hysteresis | PG_HYS | - | 4 | - | \% $\mathrm{V}_{\text {OUT }}$ | $\mathrm{V}_{\text {OUT }}$ falling |
| PG Blanking Time | PG_BLANK | - | 65 | - | $\mu \mathrm{s}$ |  |
| PG Output Leakage Current | PG_LEAK | - | 30 | - | nA |  |
| PG Sink Low Voltage | PG_SINKV | - | - | 200 | mV | $\mathrm{V}_{\text {OUT }}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{PG}}=10 \mathrm{~mA}$ |
| $\mathrm{I}^{2} \mathrm{C}$ Interface (SCL, SDA) |  |  |  |  |  |  |
| Low-Level Input Voltage | $\mathrm{V}_{\text {IL }}$ | 0 | - | 0.4 | V | $\mathrm{SV}_{\mathrm{IN}}=5.5 \mathrm{~V}$ |
| High-Level Input Voltage | $\mathrm{V}_{\mathrm{IH}}$ | 1.2 | - | 5.5 | V | $\mathrm{SV}_{\mathrm{IN}}=5.5 \mathrm{~V}$ |
| High-Level Input Current | $\mathrm{I}_{12 \mathrm{C}+\mathrm{H}}$ | -1 | 0.01 | 1 | $\mu \mathrm{A}$ |  |
| Low-Level Input Current | $\mathrm{I}_{12 \mathrm{C}=\mathrm{L}}$ | -1 | 0.01 | 1 | $\mu \mathrm{A}$ |  |
| Logic 0 Output Voltage | $\mathrm{V}_{\mathrm{OL}}$ | - | - | 0.4 | V | $\mathrm{I}_{\mathrm{SDA}}=3 \mathrm{~mA}, \mathrm{I}_{\mathrm{SCL}}=3 \mathrm{~mA}$ |
| SCL,SDA Pin Capacitance | I2C_CAP | - | 0.7 | - | pF |  |
| SDA Pull-Down Resistance | SDA_PD | - | 80 | - | $\Omega$ |  |

Note 1: Specification for packaged product only.
2: Characterized in open loop.

## ELECTRICAL CHARACTERISTICS ${ }^{(1,2)}$ (CONTINUED)

Electrical Specifications: Unless otherwise specified, $P V_{I N}=5 \mathrm{~V} ; \mathrm{V}_{\mathrm{OUT}}=1.0 \mathrm{~V} ; \mathrm{C}_{\mathrm{OUT}}=2 \times 47 \mu \mathrm{~F} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Boldface values indicate $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{J}} \leq+125^{\circ} \mathrm{C}$.

| Parameter | Symbol | Min. | Typ. | Max. | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $1^{2} \mathrm{C}$ Interface Timing |  |  |  |  |  |  |
| Maximum SCL Clock Frequency | SCL_CLOCK | - | 100 | - | kHz | Standard mode |
|  |  | - | 400 | - | kHz | Fast mode |
|  |  | - | 3.4 | - | MHz | High-Speed mode |
| Thermal Shutdown |  |  |  |  |  |  |
| Thermal Shutdown | TSHDN | - | 165 | - | ${ }^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{J}}$ rising |
| Thermal Shutdown Hysteresis | TSHDN_HYST | - | 22 | - | ${ }^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{J}}$ falling |
| Thermal Warning Threshold | $\mathrm{T}_{\text {ThWrn }}$ | - | 118 | - | ${ }^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{J}}$ rising |
| Thermal Latch-Off Soft Start Cycles | TH_LATCH | - | 4 | - | - |  |

Note 1: Specification for packaged product only.
2: Characterized in open loop.

## TEMPERATURE SPECIFICATIONS

Electrical Specifications: Unless otherwise specified, $\mathrm{PV}_{\mathrm{IN}}=5 \mathrm{~V} ; \mathrm{V}_{\mathrm{OUT}}=1.0 \mathrm{~V} ; \mathrm{C}_{\mathrm{OUT}}=2 \times 47 \mu \mathrm{~F} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$. Boldface values indicate $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{J}} \leq+125^{\circ} \mathrm{C}$.

| Parameters | Sym. | Min. | Typ. | Max. | Units | Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Temperature Ranges |  |  |  |  |  |  |
| Junction Temperature | $\mathrm{T}_{\mathrm{J}}$ | 40 | - | +125 | ${ }^{\circ} \mathrm{C}$ |  |
| Storage Temperature Range | $\mathrm{T}_{\mathrm{A}}$ | -65 | - | +150 | ${ }^{\circ} \mathrm{C}$ |  |
| Package Thermal Resistances | $\theta_{\mathrm{JA}}$ | - | 45 | - | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |  |
| Thermal Resistance, <br> 53-Lead $6 \mathrm{~mm} \times 10 \mathrm{~mm} \times 3 \mathrm{~mm}$ B1QFN |  |  |  |  |  |  |

## MIC33M656

NOTES:

### 2.0 TYPICAL CHARACTERISTIC CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

Note: Unless otherwise indicated, $\mathrm{V}_{\mathrm{IN}}=\mathrm{PV}_{\text {IN }}=A U X \_P V_{I N}=5 \mathrm{~V} ; \mathrm{V}_{\text {OUT }}=1 \mathrm{~V} ; \mathrm{C}_{\mathrm{OUT}}=2 \times 47 \mu \mathrm{~F} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.


FIGURE 2-1:
Operating Supply Current vs.
Input Voltage, Switching.


FIGURE 2-2:
High-Side Current Limits vs. Temperature ( $V_{\text {OUt }}=1.0 \mathrm{~V}$ ), Closed Loop.


FIGURE 2-3:
High-Side Current Limits vs. Temperature ( $V_{\text {OUT }}=3.3 \mathrm{~V}$ ), Closed Loop.


FIGURE 2-4: Operating Supply Current vs. Temperature, Switching.


FIGURE 2-5: $\quad R_{D S(o n)} v s$. Temperature.


FIGURE 2-6: Efficiency vs. Load Current $\left(V_{\text {OUT }}=0.6 \mathrm{~V}\right)$.

Note: Unless otherwise indicated, $\mathrm{V}_{\mathrm{IN}}=P V_{I N}=A U X \_P V_{I N}=5 \mathrm{~V} ; \mathrm{V}_{\mathrm{OUT}}=1 \mathrm{~V} ; \mathrm{C}_{\mathrm{OUT}}=2 \times 47 \mu \mathrm{~F} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.


FIGURE 2-7: Efficiency vs. Load Current ( $V_{\text {OUT }}=1.0 \mathrm{~V}$ ).


FIGURE 2-8:
Efficiency vs. Load Current
( $V_{\text {OUT }}=3.3 \mathrm{~V}$ ).


FIGURE 2-9: DCM/FPWM I IOUT Threshold
vs. $V_{I N}$.


FIGURE 2-10: Line Regulation: Output Voltage Variation vs. Input Voltage.


FIGURE 2-11: Load Regulation: VOUT Voltage Variation vs. IOUT.


FIGURE 2-12: $\quad$ Switching Frequency vs.
$I_{\text {OUT }}\left(V_{\text {OUT }}=0.6 \mathrm{~V}\right)$.

Note: Unless otherwise indicated, $\mathrm{V}_{\mathrm{IN}}=P V_{I N}=A U X \_P V_{I N}=5 \mathrm{~V} ; \mathrm{V}_{\mathrm{OUT}}=1 \mathrm{~V} ; \mathrm{C}_{\mathrm{OUT}}=2 \times 47 \mu \mathrm{~F} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.


FIGURE 2-13: Switching Frequency vs.
$I_{\text {OUT }}\left(V_{\text {OUT }}=1.0 \mathrm{~V}\right)$.


FIGURE 2-14: Switching Frequency vs.
$I_{\text {OUT }}\left(V_{\text {OUT }}=3.3 \mathrm{~V}\right.$ ).


FIGURE 2-15: Switching Frequency vs. $V_{I N}$ ( $V_{\text {OUT }}=0.6 \mathrm{~V}$ ).


FIGURE 2-16: $\quad$ Switching Frequency vs. $V_{I N}$ ( $V_{\text {OUT }}=1.0 \mathrm{~V}$ ).


FIGURE 2-17: $\quad$ Switching Frequency vs. $V_{I N}$ ( $V_{\text {OUT }}=3.3 \mathrm{~V}$ ).

## MIC33M656

Note: Unless otherwise indicated, $\mathrm{V}_{\mathrm{IN}}=\mathrm{PV}_{\mathbb{I N}}=\mathrm{AUX}_{-} \mathrm{PV}_{\mathrm{IN}}=5 \mathrm{~V} ; \mathrm{C}_{\mathrm{OUT}}=2 \times 47 \mu \mathrm{~F} ; \mathrm{TON}[1: 0]=11$; ILIM[1:0] = 11; $V_{\text {OUT }}=1 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.


FIGURE 2-18: $\quad V_{I N}$ Turn-On $\left(E N=P V_{I N}\right)$.


FIGURE 2-19: $\quad V_{I N}$ Turn-Off (EN $=P V_{I N}$ ),
$R_{\text {LOAD }}=0.3 \Omega$.



FIGURE 2-21: $\quad E N$ Turn-Off, $R_{L O A D}=0.3 \Omega$.


FIGURE 2-22: EN Turn-On into Pre-Biased Output ( $V_{\text {pre-bias }}=0.8 \mathrm{~V}$ ).


FIGURE 2-23: Power-up into Short Circuit.

Note: Unless otherwise indicated, $\mathrm{V}_{\mathrm{IN}}=\mathrm{PV}_{\mathrm{IN}}=A U X \_P V_{I N}=5 \mathrm{~V} ; \mathrm{C}_{\mathrm{OUT}}=2 \times 47 \mu \mathrm{~F} ; \mathrm{TON}[1: 0]=11 ; \operatorname{ILIM}[1: 0]=11$; $\mathrm{V}_{\text {OUT }}=1 \mathrm{~V} ; \mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$.


FIGURE 2-24: Output Current Limit
Threshold.


FIGURE 2-25: Hiccup Mode Short-Circuit Current Limit Response.


FIGURE 2-26: $\quad$ Switching Waveforms -
$I_{\text {OUT }}=50 \mathrm{~mA}$, HLL.


FIGURE 2-27: Switching Waveforms $I_{\text {OUT }}=6$.


FIGURE 2-28: Load Transient Response.


FIGURE 2-29: Line Transient Response.

## MIC33M656

NOTES:

### 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

## TABLE 3-1: PIN FUNCTION TABLE

| Pin Number | Symbol | Description |
| :---: | :---: | :---: |
| $\begin{gathered} 2,3,4,5,23,24, \\ 39,40 \end{gathered}$ | $\mathrm{P}_{\mathrm{GND}}$ | Power Ground is the ground path for the MIC33M650 power module. |
| 1,53 | AUX_PV ${ }_{\text {IN }}$ | Auxiliary Power Input Voltage Pins: Connect externally to $\mathrm{P}_{\text {VIN }}$. |
| $\begin{gathered} 6,7,8,9,10,11,12 \\ 13,14,15,16,17 \\ 18,19,20,21,22 \end{gathered}$ | SW | Switch Node Pins. SW connects to the internal MOSFETs and inductor. Do not connect any external load to this point. |
| 41, 42 | $\mathrm{PV}_{\text {IN }}$ | Power Supply Voltage Pins. |
| $\begin{gathered} 25,26,27,28,29, \\ 30,31,32,33,34, \\ 35,36,37,38 \end{gathered}$ | OUT | Output Side Connection Pins. |
| 43, 44 | SV ${ }_{\text {IN }}$ | Analog Voltage Input Pins: The power to the internal reference and control sections of the MIC33M650. Internally connected to $P V_{\text {IN }}$ through a $10 \Omega$ resistor. |
| 46, 47 | AUX_A ${ }_{\text {GND }}$ | Auxiliary Analog Ground Pins: Connect externally to $\mathrm{A}_{\text {GND }}$. |
| 45 | SCL | $I^{2} \mathrm{C}$ Clock (Input) Pin: $I^{2} \mathrm{C}$ serial bus clock input. |
| 48 | SDA | $1^{2} \mathrm{C}$ Data (Input/Output) Pin: $\mathrm{I}^{2} \mathrm{C}$ serial bus data bidirectional pin. |
| 49 | EN | Enable (Input) Pin: Logic high enables the operation of the regulator. The EN pin should not be left floating. |
| 50 | PG | Power Good (Output) Pin: This is an open-drain output that indicates when the output voltage is higher than the $91 \%$ limit. |
| 51 | $\mathrm{V}_{\text {OUT }}$ | Output Voltage Sense (Input) Pin: This pin is used to remotely sense the output voltage. Connect $\mathrm{V}_{\text {OUT }}$ as close to the output capacitor as possible to sense the output voltage. |
| 52 | $\mathrm{A}_{\text {GND }}$ | Analog Ground Pin: Internal signal ground for all low-power circuits. |
| 54 | EP_OUT | Exposed Thermal Pad: Internally connected to OUT. |
| 55 | EP_SW | Exposed Thermal Pad: Internally connected to SW node. |
| 56 | EP_P ${ }_{\text {GND }}$ | Exposed Thermal Pad: Internally connected to $\mathrm{P}_{\text {GND }}$. |
| 57 | $E P_{-} \mathrm{PV}_{\text {IN }}$ | Exposed Thermal Pad: Internally connected to PVIN. |

### 3.1 Power Ground Pin ( $\mathrm{P}_{\mathrm{GND}}$ )

$P_{G N D}$ is the ground path for the MIC33M656 buck converter power stage. The $\mathrm{P}_{\text {GND }}$ pin connects to the sources of the low-side N-channel MOSFET, the negative terminals of the input capacitors and the negative terminals of the output capacitors. The loop for the Power Ground should be as small as possible and separate from the Analog Ground ( $\mathrm{A}_{\mathrm{GND}}$ ) loop.

### 3.2 Switch Node Pin (SW)

Switching node output pin which connects to the internal MOSFETs and inductor. This is a high-frequency connection; therefore, traces should be kept as short and as wide as practical.

### 3.3 Input Voltage Pin ( $\mathrm{PV}_{\mathrm{IN}}$ )

Input supply to the source of the internal high-side P -channel MOSFET. The $\mathrm{PV}_{\mathrm{IN}}$ operating voltage range is from 2.4 V to 5.5 V . An input capacitor between $\mathrm{PV}_{\mathrm{IN}}$ and the Power Ground ( $\mathrm{P}_{\mathrm{GND}}$ ) pin is required and placed as close as possible to the IC.

### 3.4 Analog Voltage Input Pin (SV $\mathrm{IN}_{\mathrm{IN}}$ )

The power to the internal reference and control sections of the MIC33M656. Internally connected to PV ${ }_{\text {IN }}$ through a $10 \Omega$ resistor.

## $3.5 \quad \mathrm{I}^{2} \mathrm{C}$ Clock Input Pin (SCL)

The SCL pin is the serial interface's serial clock pin. This pin is connected to the host controller SCL pin.
The MIC33M656 is a slave device, so its SCL pin is only an input.

## 3.6 $\quad I^{2} C$ Data Input/Output Pin (SDA)

The SDA pin is the serial interface's serial data pin. This pin is connected to the host controller SDA pin. The SDA pin has an open-drain N -channel driver.

### 3.7 Enable Pin (EN)

Logic high enables operation of the regulator. Logic low will shut down the device. In the OFF state, the supply current of the device is greatly reduced (typically $1.5 \mu \mathrm{~A})$. The EN pin should not be left open.

### 3.8 Power Good Pin (PG)

This is an open-drain output that indicates when the rising output voltage is higher than the $91 \%$ threshold. There is a $4 \%$ hysteresis; therefore, PG will return low when the output voltage falls below $87 \%$ of the target regulation voltage.

### 3.9 Output Voltage Sense Pin (V $\mathrm{V}_{\text {OUT }}$ )

This pin is used to remotely sense the output voltage. Connect to $\mathrm{V}_{\text {OUT }}$ as close to the output capacitor as possible to sense the output voltage. This pin also provides the path to discharge the output through an internal $10 \Omega$ resistor when the device is disabled.

### 3.10 Analog Ground Pin ( $\mathrm{A}_{\mathrm{GND}}$ )

Internal signal ground for all low-power circuits. Connect to ground plane. For best load regulation, the connection path from $A_{G N D}$ to the output capacitor ground terminal should be free from parasitic voltage drops.

### 3.11 Auxiliary Analog Ground Pins (AUX_A ${ }_{G N D}$ )

Connect these pins to $A_{G N D}$ to make use of the internal decoupling capacitor for $\mathrm{SV}_{\mathrm{IN}}$ pin filtering.

### 3.12 Auxiliary Input Voltage Pins (AUX_PV ${ }_{\text {IN }}$ )

Connect these pins to $P V_{\mathbb{I N}}$ to make use of the internal $10 \mu \mathrm{~F}$ capacitor for $\mathrm{PV}_{\text {IN }}$ filtering/decoupling.

## $3.13 \mathrm{P}_{\mathrm{GND}}$ Exposed Pad (EP_P $\mathrm{P}_{\mathrm{GND}}$ )

Electrically connected to the $\mathrm{P}_{\mathrm{GND}}$ pins. Connect with thermal vias to the ground plane to ensure adequate heat sinking. See Section 8.0 "Packaging Information".

### 3.14 OUT Exposed Pad (EP_OUT)

Electrically connected to the OUT pins. Must be externally connected to the output power connection.

### 3.15 SW Exposed Pad (EP_SW)

Electrically connected to the SW node.

### 3.16 $\mathrm{PV}_{\text {IN }}$ Exposed Pad (EP_PV ${ }_{\text {IN }}$ )

Electrically connected to the $P V_{I N}$ pins. Must be connected to the input power connection.

### 4.0 FUNCTIONAL DESCRIPTION

### 4.1 Device Overview

The MIC33M656 is a high-efficiency 6A peak current, synchronous buck regulator with HyperLight Load mode. The module integrates the inductor alongside high-frequency, ripple dampening capacitors on the input and output of the converter and decoupling capacitor for the signal input. The Constant-On-Time (COT) control architecture with automatic HyperLight Load mode provides very high efficiency at light loads and ultra-fast transient response.
The MIC33M656 output voltage is programmed through the $\mathrm{I}^{2} \mathrm{C}$ interface, in the range of 0.6 V to 1.28 V , with 5 mV resolution (options YMP, HAYMP and FAYMP), or between 0.6 V and 3.84 V (option SAYMP). The latter option has a 10 mV resolution, from 0.6 V up to 1.28 V and a 20 mV resolution, from 1.28 V to 3.84 V .
The 2.4 V to 5.5 V input voltage operating range makes the device ideal for single-cell Li-ion battery-powered applications. Automatic HyperLight Load mode provides very high efficiency at light loads.
This device focuses on high output voltage accuracy. Total output error is less than $1.5 \%$ over line, load and temperature.

The MIC33M656 buck regulator uses an adaptive Constant-On-Time control method. The adaptive on-time control scheme is employed to obtain a nearly constant switching frequency in Continuous Conduction mode. Overcurrent protection is implemented by sensing the current on both the low-side and high-side internal power MOSFETs. The device includes an internal soft start function, which reduces the power supply input surge current at start-up by controlling the output voltage rise time.

### 4.2 HyperLight Load Mode (HLL)

HLL is a power-saving switching mode. In HLL, the switching frequency is not constant over the operation current range. At light loads, the fixed on-time operation, coupled with low-side MOSFET diode emulation, causes the switching frequency to decrease. This reduces switching and drive losses, and increases efficiency. The HLL switching mode can be disabled for reduced output ripple and low noise by setting the FPWM bit in the CTRL2 register.

### 4.3 Enable (EN Pin)

When the EN pin is pulled low, the IC is in a shutdown state with all internal circuits disabled and with the Power Good (PG) output low. During shutdown, the part typically consumes $1.5 \mu \mathrm{~A}$. When the EN pin is pulled high, the start-up sequence is initiated. There is a programmable enable delay that is used to delay the start of the output ramp. The enable delay timer can be programmed to one of four time intervals of 0.25 ms , $1 \mathrm{~ms}, 2 \mathrm{~ms}$ or 3 ms in the CTRL1 register. Note that if the 0 ms delay setting is chosen, there is an internal delay of $250 \mu$ s before the part will start to switch in order to bias up internal circuitry.

## $4.4 \quad I^{2} \mathrm{C}$ Programming

The MIC33M656 behaves as an $I^{2} \mathrm{C}$ slave, accessible at 0x5B (7-bit addressing).
The $I^{2} \mathrm{C}$ interface remains active and the MIC33M656 can be programmed whether the Enable pin is high or low, as long as the input voltage is above the UVLO threshold. This feature is useful in applications where a housekeeping MCU preconfigures the MIC33M656 before enabling power delivery. The registers do not get reset when the enable pin is low. The output voltage can be programmed to a new value with $I^{2} \mathrm{C}$, regardless of the EN pin status. If the EN pin is high, the output voltage will move to the newly programmed value on-the-fly, with the programmed slew rate.

### 4.5 Power Good (PG)

The Power Good output is generally used for power sequencing where the Power Good output is tied to the enable output of another regulator. This technique avoids all the regulators powering up at the same time, causing large inrush current.
The Power Good output is an open-drain output. During start-up, when the output voltage is rising, the Power Good output goes high by means of an external pull-up resistor when the output voltage reaches $91 \%$ of its set value. The Power Good threshold has $4 \%$ hysteresis, so the Power Good output stays high until the output voltage falls below $87 \%$ of the set value. A built-in $65 \mu$ s blanking time is incorporated to prevent nuisance tripping.
The pull-up resistor from the PG pin can be connected to $\mathrm{V}_{\text {IN }}, \mathrm{V}_{\text {OUT }}$ or an external source that is less than or equal to $V_{\text {IN }}$. The PG pin can be connected to another regulator's enable pin for sequencing of the outputs. The PG output is deasserted as soon as the Enable pin is pulled low, or an input undervoltage condition or any other Fault is detected.

### 4.6 Output Soft Discharge Option

To ensure a known output condition when the device is turned off, then back on again, the output is actively discharged to ground by means of an internal $10 \Omega$ resistor. The active discharge resistor can be enabled or disabled through $I^{2} \mathrm{C}$ in the CTRL2 register.

### 4.7 Output Voltage Setting

The MIC33M656 output voltage has an 8-bit control DAC that can be programmed from 0.6 V to 1.28 V , in 5 mV increments, for part options HAYMP and FAYMP. Option SAYMP can be programmed from 0.6 V , up to 1.28 V , with 10 mV resolution and from 1.28 V up to 3.84 V , with 20 mV resolution. This can be programmed in the Output Voltage Control (VOUT) register.
The output voltage sensing pin, $\mathrm{V}_{\text {OUT }}$, should be connected exactly to the desired Point-of-Load (POL) regulation, avoiding parasitic resistive drops.

### 4.8 Converter Stability/Output Capacitor

The MIC33M656 utilizes an internal compensation network and it is designed to provide stable operation with output capacitors from $47 \mu \mathrm{~F}$ to $1000 \mu \mathrm{~F}$. This greatly simplifies the design where supplementary output capacitance can be added without affecting stability.

### 4.9 Soft Start

Excess bulk capacitance on the output can cause excessive input inrush current. The MIC33M656 internal soft start feature forces the output voltage to rise gradually, keeping the inrush current at reasonable levels. This is particularly important in battery-powered applications. The ramp rate can be set in the CTRL2 register by means of the SLEW_RATE[3:0] bits (see Register 7-2).
When the enable pin goes high, the output voltage starts to rise. Once the soft start period has finished, the Power Good comparator is enabled and if the output voltage is above $91 \%$ of the nominal regulation voltage, then the Power Good output goes high.
The output voltage soft start time is determined by the soft start equation below. The Soft Start Time, $\mathrm{t}_{\mathrm{SS}}$, can be calculated using Equation 4-1.

## EQUATION 4-1:

$$
\begin{gathered}
t_{S S}=V_{O U T} \times t_{R A M P} \\
t_{S S}=1.0 \mathrm{~V} \times 800 \mu \mathrm{~s} / \mathrm{V} \\
t_{S S}=800 \mu \mathrm{~s}=0.8 \mathrm{~ms}
\end{gathered}
$$

Where:

$$
\begin{aligned}
\mathrm{V}_{\text {OUT }} & =1.0 \mathrm{~V} \\
\mathrm{t}_{\text {RAMP }} & =800 \mu \mathrm{~s} / \mathrm{V}
\end{aligned}
$$

### 4.10 100\% Duty Cycle Operation

The MIC33M656 can deliver $100 \%$ duty cycle. To achieve $100 \%$ duty cycle, the high-side switch is latched on when the duty cycle reaches around $92 \%$ and stays latched until the output voltage falls $4 \%$ below its regulated value. This feature is especially useful in battery-operated applications. It is recommended that this feature is enabled together with the highest TON setting, corresponding to the lowest switching frequency (TON[1:0] = 00 in the CTRL1 register). The high-side latch circuitry can be disabled by setting the DIS_100PCT bit in the CTRL2 register to ' 1 '.

### 4.11 Switching Frequency

The switching frequency of the MIC33M656 is indirectly set by programming the TON value. The equation below provides an estimation for the resulting switching frequency:

EQUATION 4-2:

$$
f_{S W}=\frac{V_{O U T}}{V_{I N}} \times \frac{1}{T_{O N}}
$$

Equation 4-2 is valid only in Continuous Conduction mode and for a loss-less converter. In practice, losses will cause an increase of the switching frequency with respect to the ideal case. As the load current increases, losses will increase too and so will the switching frequency.
The on-time calculation is adaptive, in that the $\mathrm{T}_{\mathrm{ON}}$ value is modulated based on the input voltage, and on the target output voltage, to stabilize the switching frequency against their variations. Losses are not accounted for.
The table below highlights the resulting On Time ( $\mathrm{T}_{\mathrm{ON}}$ ) for typical output voltages:

TABLE 4-1: ON-TIME CALCULATIONS

|  |  | TON |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathbf{V}_{\text {IN }} \mathbf{( V )}$ | $\mathbf{V}_{\text {OUT }} \mathbf{( V )}$ | [00] | [01] | [10] | [11] |
| 5 | 0.6 | 140 | 110 | 100 | 80 |
|  | 1 | 260 | 180 | 130 | 105 |
|  | 1.8 | 520 | 340 | 200 | 150 |
|  | 2.5 | 740 | 490 | 260 | 190 |
|  | 3.3 | 930 | 610 | 310 | 220 |
|  | 1 | 380 | 270 | 170 | 130 |

### 4.12 Undervoltage Protection (UVLO)

Undervoltage protection ensures that the IC has enough voltage to bias the internal circuitry properly and provide sufficient gate drive for the power MOSFETs. When the input voltage starts to rise, both power MOSFETs are off and the Power Good output is pulled low. The IC starts at approximately 2.225 V typical and has a nominal 153 mV of hysteresis to prevent chattering between the UVLO high and low states.

### 4.13 Overtemperature Fault

The MIC33M656 monitors the die junction temperature to keep the IC operating properly. If the IC junction temperature exceeds $+118^{\circ} \mathrm{C}$, the warning flag, "OT_WARN", is set, but does not affect the operation mode. It automatically resets if the junction temperature drops below the temperature threshold. If the IC junction temperature exceeds $+165^{\circ} \mathrm{C}$, both power MOSFETs are immediately turned off. The IC is allowed to start when the die temperature falls below $+143^{\circ} \mathrm{C}$.
During the Fault condition, several changes will occur in the STATUS Register. The OT bit will go high, indicating the junction temperature reached $+165^{\circ} \mathrm{C}$, while the OT_WARN automatically resets. If the controller is enabled to restart after the first thermal shutdown event (OT_LATCH bit in CTRL2 register is set), the SSD bit will go low and the HICCUP bit will go high. Finally, the PG bit in the FAULT register (address 0x03) will go low and the PG pin will be pulled low until the output voltage has restarted and is once again in regulation. The $\mathrm{I}^{2} \mathrm{C}$ interface remains active and all the values stored in registers are maintained. When the die temperature decreases below the lower thermal shutdown threshold, and the MIC33M656 resumes switching with the output voltage going back in regulation, the global Power Good output is pulled high, but the Overtemperature Fault bit, OT, is still set to ' 1 '. To clear the Fault, either recycle input power or write a logic ' 0 ' to the Overtemperature bit, OT, in the FAULT register.
During recovery from a thermal shutdown event, if the regulator hits another thermal shutdown event before Power Good can be achieved, the controller will again reset. If this happens four times in a row, the part will be in a Latch-Off state and the MOSFETs are permanently latched off. The LATCH_OFF bit in the STATUS Register will be set to ' 1 ', which will latch off the MIC33M656. The device can be restarted by toggling the enable input, by recycling the input power or by software Enable Control (EN_CON). This latch-off feature eliminates the thermal stress on the MIC33M656 during a Fault event. The OT_LATCH bit in the CTRL2 register can be set to ' 0 ', which will cause this latch-off to happen after the first overtemperature event, instead of waiting for four consecutive overtemperatures. This is a more conservative approach to protect the part and is available to the user.

### 4.14 Safe Start-up into a Pre-Biased Output

The MIC33M656 is designed for safe start-up into a pre-biased output in forced PWM. This feature prevents high negative inductor current flow in a pre-bias condition, which can damage the IC. This is achieved by not allowing forced PWM until the control loop commands eight switching cycles. After eight cycles, the low-side negative current limit is switched from 0 A to -3 A . The cycle counter is reset to zero if the Enable pin is pulled low, or an input undervoltage condition or any other Fault is detected.

### 4.15 Current Limiting

The MIC33M656 regulator uses both high-side and low-side current sense for current limiting. When the high-side current sense threshold is reached, the high-side MOSFET is turned off and the low-side MOSFET is turned on. The low-side MOSFET stays on until the current falls to $80 \%$ of the high-side current threshold value, then the high-side current can be turned on again. If the overload condition lasts for more than seven cycles, the MIC33M656 enters hiccup current limiting and both MOSFETs are turned off. There is a 1 ms cool-off period before the MOSFETs are allowed to be turned on. If the regulator has another hiccup event before it reaches the Power Good threshold on restart, it will again turn off both MOSFETs and wait for 1 ms . If this happens more than three times in a row, then the part will enter the Latch-Off state, which will permanently turn off both MOSFETs until the part is reset by toggling the EN pin, recycling power or via an $\mathrm{I}^{2} \mathrm{C}$ command.
During a hiccup event, the HICCUP bit in the STATUS Register will go high and the SSD bit will go low until the output has recovered. The Power Good FAULT register bit, PG, will also go low and the PG pin will be pulled low. In latch-off, the LATCH_OFF status bit is set to ' 1 '.
The high-side current limit can be programmed by setting the ILIM[1:0] bits in the CTRL1 register. For maximum efficiency and current limit precision, the highest current limit must be programmed together with a higher TON setting (corresponding to a lower frequency).

### 4.16 Thermal Considerations

Although the MIC33M656 is capable of delivering up to 6 A under load, the package thermal resistance and the device internal power dissipation may dictate some limitations to the continuous output current.
As a reference, for $\mathrm{V}_{\mathrm{IN}}=5 \mathrm{~V}, \mathrm{~V}_{\text {OUT }}=1 \mathrm{~V}$, $\mathrm{I}_{\text {OUT }}=5 \mathrm{~A}$, the DT100108 Evaluation Board application shows a stable $+40^{\circ} \mathrm{C}$ chip self-heating.
For $\mathrm{V}_{\text {IN }}=5 \mathrm{~V}$, $\mathrm{V}_{\text {OUT }}=3.3 \mathrm{~V}$, the same self-heating is produced at about 4A.
If operated above the rated junction temperature, electrical parameters may drift beyond characterized specifications. The MIC33M656 is protected under all circumstances by thermal shutdown.

## MIC33M656

NOTES:

### 5.0 APPLICATION INFORMATION

### 5.1 Power-up State

When power is first applied to the MIC33M656 and the Enable pin is high, all $\mathrm{I}^{2} \mathrm{C}$ registers are loaded with their default values and the device starts delivering power to the output based on those default values. After the soft start ramp has finished, these registers can be reconfigured. These new settings are saved, even if the Enable pin is pulled low. When the Enable pin is pulled high again, the MIC33M656 is configured to the new register settings, not the original default settings. To set the $I^{2} \mathrm{C}$ registers to their original settings, the input power has to be recycled.
When power is first applied to the MIC33M656 and the Enable pin is low, all $I^{2} \mathrm{C}$ registers can be configured. When the Enable pin is pulled high, the regulator will power up with the new $I^{2} \mathrm{C}$ register settings. Again, these register settings will not be lost when the Enable pin is pulled low. If power is recycled, the register settings are lost and they will have to be reprogrammed.

### 5.2 Output Voltage Sensing

To achieve accurate output voltage regulation, the $\mathrm{V}_{\text {OUT }}$ pin (internal feedback divider top terminal) should be Kelvin connected as close as possible to the point of regulation top terminal. Since both the internal reference and the internal feedback divider's bottom terminal refer to $A_{G N D}$, it is important to minimize voltage drops between $\mathrm{A}_{\mathrm{GND}}$ and the point of regulation return terminal (typically, the ground terminal of the output capacitor which is closest to the load).

### 5.3 Digital Voltage Control (DVC)

When the buck converter is programmed to a lower voltage, the regulator is placed into forced PWM mode and the Power Good monitor is blanked during the transition time.

### 5.4 Output Capacitor Selection

The MIC33M656 utilizes an internal compensation network and is designed to provide stable operation, with output capacitors from $47 \mu \mathrm{~F}$ to $1000 \mu \mathrm{~F}$. This greatly simplifies the design, where supplementary output capacitance can be added without affecting stability.

The type of output capacitor is usually determined by its Equivalent Series Resistance (ESR). Voltage and RMS current capability are two other important factors to consider when selecting the output capacitor. Recommended capacitor types are ceramic, OS-CON and POSCAP. The output capacitor ESR is usually the main cause of the output ripple. The output capacitor ESR also affects the control loop from a stability point of view. The maximum value of ESR is calculated using Equation 5-1.

EQUATION 5-1:

|  | ${ }^{E S R_{C_{O U T}}} \leq \frac{\Delta V_{O U T(P P)}}{\Delta I_{L(P P)}}$ |
| :---: | :---: |
| Where: |  |
| $\Delta \mathrm{V}_{\text {OUT(PP) }}$ | $=$ Peak-to-Peak Output Voltage Ripple |
| $\Delta L_{\text {LPP })}$ | $=$ Peak-to-Peak Inductor Current Ripple |

The peak-to-peak inductor current ripple can be calculated by using the formula in Equation 5-3.

EQUATION 5-2:

$$
\Delta I_{L(P P)}=\frac{V_{O U T} \times\left(V_{I N(M A X)}-V_{O U T}\right)}{V_{I N(M A X)} \times f_{S W} \times L}
$$

Where:

$$
L=0.47 \mu \mathrm{H}
$$

The total output ripple is a combination of the ESR and output capacitance. The total ripple is calculated in Equation 5-3.

## EQUATION 5-3:

$$
\Delta V_{O U T(P P)}=\sqrt{\left(\frac{\Delta I_{L(P P)}}{C_{O U T} \times f_{S W} \times 8}\right)^{2}+\left(\Delta I_{L(P P)} \times E S R_{C_{O U T}}\right)^{2}}
$$

Where:

$$
\begin{aligned}
\mathrm{C}_{\text {OUT }} & =\text { Output Capacitance Value } \\
\mathrm{f}_{\mathrm{SW}} & =\text { Switching Frequency }
\end{aligned}
$$

The output capacitor RMS current is calculated in Equation 5-4.

## EQUATION 5-4:

$$
{ }^{I} C_{\text {OUT }(R M S)}=\frac{\Delta_{L(P P)}}{\sqrt{12}}
$$

The power dissipated in the output capacitor is:

## EQUATION 5-5:

$$
P_{D I S S(C O U T)}=I_{C O U T(R M S)}{ }^{2} \times E S R C O U T
$$

## MIC33M656

### 5.5 Input Capacitor Selection

The MIC33M656 integrates high-frequency input bypass capacitors connected between $P V_{I N}$ and $P_{G N D}$, and an additional $10 \mu \mathrm{~F}$, low-ESR ceramic capacitor for input ripple smoothing, connected between $\mathrm{P}_{\text {GND }}$ and $A U X \_P V_{I N}$. Therefore, the connection between $P V_{I N}$ and $A U X \_P V_{I N}$ should have very low stray resistance and inductance (i.e., many vias) to take advantage of the internal $10 \mu \mathrm{~F}$ capacitor. While the internal $10 \mu \mathrm{~F}$ capacitor can support the RMS ripple current, additional external input ceramic capacitors can be added optionally to further attenuate the input voltage ripple amplitude. The need for additional external input capacitance also depends on the impedance of the input supply distribution network.

## 5.6 $\quad I^{2} \mathrm{C}$ Bus Pull-ups Selection

The optimal pull-up resistors must be strong enough such that the RC constant of the bus is not too large (causing the line not to rise to a logical high before being pulled low), but weak enough for the IC to drive the line low (see Table 5-1).

TABLE 5-1: $\quad I^{2} C$ BUS CONSTRAINTS

|  | Standard <br> Mode | Fast <br> Mode | High-Speed <br> Mode |  |
| :--- | :---: | :---: | :---: | :---: |
| Bit Rate <br> (kbits/s) | 0 to 100 | 0 to 400 | 0 to 1700 | 0 to 3400 |
| Max Cap <br> Load (pF) | 400 | 400 | 400 | 100 |
| Rise Time <br> (ns) | 1000 | 300 | 160 | 80 |
| Spike <br> Filtered (ns) | N/A | 50 | 10 |  |

## EQUATION 5-6:

$$
R p(\min )=\frac{V_{C C}-V_{O L}(\max )}{I_{O L}}
$$

Where:

$$
\begin{aligned}
\mathrm{V}_{\mathrm{CC}} & \left.=\text { Pull-up Reference Voltage (i.e., } \mathrm{V}_{\mathrm{IN}}\right) \\
\mathrm{V}_{\mathrm{OL}}(\max ) & =0.4 \mathrm{~V} \\
\mathrm{I}_{\mathrm{OL}} & =3 \mathrm{~mA}
\end{aligned}
$$

## $6.0 \quad I^{2} \mathrm{C}$ INTERFACE DESCRIPTION

The $1^{2} \mathrm{C}$ bus is for 2-way, 2 -line communication between different ICs or modules. The two lines are: a Serial Data line (SDA) and a Serial Clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor. Data transfer may be initiated only when the bus is not busy. MIC33M656 is a slave only device (i.e., it cannot generate a SCL signal and does not have SCL clock stretching capability). Every data transfer, to and from the MIC33M656, must be initiated by a master device which drives the SCL line.


FIGURE 6-1: Bit Transfer Diagram.

### 6.1 Bit Transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the high period of the clock pulse as changes in the data line, at this time, will be interpreted as control signals.

### 6.2 Start and Stop Conditions

Both data and clock lines remain high when the bus is not busy. A high-to-low transition of the data line, while the clock is high, is defined as the Start (S) or Repeated

Start (Sr) condition. A low-to-high transition of the data line while the clock is high is defined as the Stop condition ( P ). Start and Stop conditions are always generated by the master. The bus is considered to be busy after the Start condition. The bus is considered to be free again a certain time after the Stop condition. The bus stays busy if a Repeated Start (Sr) is generated instead of a Stop condition.


FIGURE 6-2: $\quad$ Start and Stop Conditions.

### 6.3 Device Address

The MIC33M656 device uses a fixed 7-bit address, which is set in hardware. This address is ' $0 \times 5 \mathrm{~B}$ '.

### 6.4 Acknowledge

The number of data bytes transferred between the Start and the Stop conditions, from transmitter to receiver, is not limited. Each byte of eight bits is followed by one Acknowledge bit. The Acknowledge bit is a high level put on the bus by the transmitter, whereas the master generates an extra Acknowledge related clock pulse. The device that Acknowledges has to pull down the SDA line during the Acknowledge clock pulse, so that the SDA line is stable low during the high period of the Acknowledge related clock pulse; setup and hold times must be taken into account.

A slave receiver, which is addressed, must generate an Acknowledge after the reception of each byte.
Also, a master receiver must generate an Acknowledge after the reception of each byte that has been clocked out of the slave transmitter, except on the last received byte. A master receiver must signal an end of data to the transmitter by not generating an Acknowledge on the last byte that has been clocked out of the slave transmitter. In this event, the transmitter must leave the data line high to enable the master to generate a Stop condition.

### 6.5 Bus Transactions

### 6.5.1 SINGLE WRITE

The first seven bits of the first byte make up the slave address. The eighth bit is the LSb (Least Significant bit). It determines the direction of the message (R/W). A ' 0 ' in the least significant position of the first byte
means that the master will write information to a selected slave. A ' 1 ' in this position means that the master will read information from the slave. When an address is sent, each device in a system compares the first seven bits after the Start condition with its address. If they match, the device considers itself addressed by the master as a slave-receiver or slave-transmitter, depending on the R/W bit.
A command byte is a data byte which selects a register on the device. The Least Significant six bits of the command byte determine the address of the register that needs to be written.

The data to port are the 8-bit data that need to be written to the selected register. This is followed by the Acknowledge from the slave and then the Stop condition.
The Write command is as follows and it is illustrated in the timing diagram shown in Figure 6-3:

1. Send Start sequence.
2. Send 7-bit slave address.
3. Send the R/W bit - ' 0 ' to indicate a write operation.
4. Wait for Acknowledge from the slave.
5. Send the command byte containing the address that needs to be written.
6. Wait for Acknowledge from the slave.
7. Receive the 8-bit data from the master and write them to the slave register, indicated in Step 5, starting from the MSB.
8. Acknowledge from the slave.
9. Send Stop sequence.

Note: Writing to a non-existing register location will have no effect.


FIGURE 6-3: Single Write Timing Diagram.

### 6.5.2 SINGLE READ

This reads a single byte from a device, from a designated register. The register is specified through the command byte.
The Read command is as follows and it is illustrated in the timing diagram of Figure 6-4 below.

1. Send Start sequence.
2. Send 7-bit slave address.
3. Send the R/W bit - ' 0 ' to indicate a write operation.
4. Wait for Acknowledge from the slave.
5. Send the register address that needs to be read.
6. Wait for Acknowledge from the slave.
7. Send Start sequence again (Repeated Start condition).
8. Send the 7-bit slave address.
9. Send R/W bit - ' 1 ' to indicate a read operation.
10. Wait for Acknowledge from the slave.
11. Receive the 8 -bit data from the slave starting from MSB.
12. Acknowledge from the master. On the received byte, the master receiver issues a NACK in place of an ACK to signal the end of the data transfer.
13. Send Stop sequence.

Note: Attempts to read from a non-existing register location will return all zeros.


FIGURE 6-4:
Single Read Timing Diagram.

## MIC33M656

NOTES:

### 7.0 REGISTER MAP AND ${ }^{2} \mathrm{C}$ PROGRAMMABILITY

The MIC33M656 internal registers are summarized in the MIC33M656 Register Map.

TABLE 7-1: MIC33M656 REGISTER MAP

| Address | Register Name |  |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $0 \times 00$ | Control Register (CTRL1) |  |  |  |  |  |  |  |
|  | TON[1:0] |  | ILIM[1:0] |  | EN_DELAY[1:0] |  | EN_INT | EN_CON |
| $0 \times 01$ | Output Control Register (CTRL2) |  |  |  |  |  |  |  |
|  | DIS_100PCT | FPWM | OT_LATCH | PULL_DN | SLEW_RATE[3:0] |  |  |  |
| $0 \times 02$ | Output Voltage Register (VOUT) |  |  |  |  |  |  |  |
|  | VO[7:0] |  |  |  |  |  |  |  |
| $0 \times 03$ | Status and Fault Register (FAULT) |  |  |  |  |  |  |  |
|  | OT_WARN | EN_STAT | BOOT_ERR | SSD | HICCUP | OT | LATCH_OFF | PG |

REGISTER 7-1: CTRL1: CONTROL REGISTER (ADDRESS 0x00)

| R/W-V R/W-V | R/W-V | R/W-V | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TON[1:0] | ILIM[1:0] | EN_DELAY[1:0] | EN_INT | EN_CON |  |  |
| bit 7 |  |  |  | bit 0 |  |  |


| Legend: | $V=$ Factory programmed POR value |  |
| :--- | :--- | :--- |
| $R=$ Readable bit | $\mathrm{W}=$ Writable bit | $\mathrm{U}=$ Unimplemented bit, read as ' 0 ' |
| $-\mathrm{n}=$ Value at POR | $' 1$ ' = Bit is set | $' 0$ ' = Bit is cleared $\quad \mathrm{x}=$ Bit is unknown |

bit 7-6 TON[1:0]: On Time
00 = Low frequency
$01=$ Medium frequency
$10=$ High frequency
11 = Very high frequency
bit 5-4 ILIM[1:0]: High-Side Peak Current Limit
$00=3.5 \mathrm{~A}$
$01=5 \mathrm{~A}$
$10=8.5 \mathrm{~A}$
$11=10 \mathrm{~A}$
bit 3-2 EN_DELAY[1:0]: Enable Delay
$00=250 \mu \mathrm{~s}$
$01=1 \mathrm{~ms}$
$10=2 \mathrm{~ms}$
$11=3 \mathrm{~ms}$
bit 1 EN_INT: Enable Bit Register Control
$0=$ Register controlled
1 = Enable pin controlled
bit 0 EN_CON: Enable Control
$0=$ Off
$1=O n$

## MIC33M656

REGISTER 7-2: CTRL2: OUTPUT CONTROL REGISTER (ADDRESS 0x01)

| R/W-0 | R/W-0 | R/W-V | R/W-V | R/W-V | R/W-V | R/W-V | R/W-V |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIS_100PCT | FPWM | OT_LATCH | PULLDN |  | SLEW_RATE[3:0] |  |  |
| bit 7 |  |  | bit 0 |  |  |  |  |


| Legend: | $V=$ Factory programmed POR value |  |
| :--- | :--- | :--- |
| $R=$ Readable bit | $\mathrm{W}=$ Writable bit | $\mathrm{U}=$ Unimplemented bit, read as ' 0 ' |
| $-\mathrm{n}=$ Value at POR | $' 1$ ' = Bit is set | $' 0$ ' = Bit is cleared $\quad \mathrm{x}=$ Bit is unknown |

bit 7 DIS_100PCT: Disable 100\% Duty Cycle
$0=100 \%$ DC
1 = Disable 100\% DC
bit $6 \quad$ FPWM: Force PWM
$0=\mathrm{HLL}$
1 = FPWM
bit 5 OT_LATCH: Overtemperature Latch
0 = Latch off immediately
1 = Latch off after four OT cycles
bit 4 PULLDN: Enable/Disable Regulator Pull-Down when Power-Down
$0=$ No pull-down
1 = Pull-down
bit 3-0 SLEW_RATE[3:0]: Step Slew Rate Time in $\mu \mathrm{s} / \mathrm{V}$
$0000=200$
$0001=400$
$0010=600$
$0011=800$
$0100=1000$
$0101=1200$
$0110=1400$
$0111=1600$
$1000=1800$
$1001=2000$
$1010=2200$
$1011=2400$
$1100=2600$
$1101=2800$
$1110=3000$
$1111=3200$

## REGISTER 7-3: VOUT: OUTPUT VOLTAGE CONTROL REGISTER (ADDRESS 0x02)

| $R / W-V$ | $R / W-V$ | $R / W-V$ | $R / W-V$ | $R / W-V$ | $R / W-V$ | $R / W-V$ | $R / W-V$ |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- | :--- |
|  |  | $V O[7: 0]$ |  |  |  |  |  |
| bit 7 |  |  |  |  |  | bit 0 |  |


| Legend: | $\mathrm{V}=$ Factory programmed POR value |  |
| :--- | :--- | :--- |
| $R=$ Readable bit | $\mathrm{W}=$ Writable bit | $\mathrm{U}=$ Unimplemented bit, read as ' 0 ' |
| $-\mathrm{n}=$ Value at POR | $' 1$ ' = Bit is set | ' 0 ' = Bit is cleared $\quad \mathrm{x}=$ Bit is unknown |

bit 7-0 VO[7:0]: Output Voltage Control (HAYMP, FAYMP options)
For codes $0 \times 00$ to $0 \times 76: 0.6 \mathrm{~V}$.

|  | $0 \times 80=0.645$ | $0 \times \mathrm{A} 0=0.805 \mathrm{~V}$ | $0 \times C 0=0.965$ | $0 x E 0=1.125 \mathrm{~V}$ |
| :---: | :---: | :---: | :---: | :---: |
|  | $0 \times 81=0.65 \mathrm{~V}$ | $0 \times \mathrm{A} 1=0.81 \mathrm{~V}$ | $0 \mathrm{xC1}=0.97 \mathrm{~V}$ | $0 x E 1=1.13 \mathrm{~V}$ |
|  | $0 \times 82=0.655 \mathrm{~V}$ | $0 \times \mathrm{A} 2=0.815 \mathrm{~V}$ | $0 \times C 2=0.975 \mathrm{~V}$ | 0xE2 $=1.135 \mathrm{~V}$ |
|  | $0 \times 83=0.66 \mathrm{~V}$ | $0 \times \mathrm{A} 3=0.82 \mathrm{~V}$ | $0 \mathrm{xC3}=0.98 \mathrm{~V}$ | $0 x E 3=1.14 \mathrm{~V}$ |
|  | $0 \times 84=0.665 \mathrm{~V}$ | $0 \times \mathrm{A} 4=0.825 \mathrm{~V}$ | $0 \times C 4=0.985 \mathrm{~V}$ | 0xE4 $=1.145 \mathrm{~V}$ |
|  | $0 \times 85=0.67 \mathrm{~V}$ | $0 \times \mathrm{A} 5=0.83 \mathrm{~V}$ | $0 \mathrm{xC5}=0.99 \mathrm{~V}$ | $0 x E 5=1.15 \mathrm{~V}$ |
|  | $0 \times 86=0.675 \mathrm{~V}$ | $0 \times \mathrm{A} 6=0.835 \mathrm{~V}$ | $0 \times C 6=0.995 \mathrm{~V}$ | 0xE6 $=1.155 \mathrm{~V}$ |
|  | $0 \times 87=0.68 \mathrm{~V}$ | $0 \times \mathrm{A} 7=0.84 \mathrm{~V}$ | $0 \times C 7=1 \mathrm{~V}$ | $0 x E 7=1.16 \mathrm{~V}$ |
|  | $0 \times 88=0.685 \mathrm{~V}$ | $0 \times \mathrm{A} 8=0.845 \mathrm{~V}$ | $0 \times C 8=1.005 \mathrm{~V}$ | 0xE8 $=1.165 \mathrm{~V}$ |
|  | $0 \times 89=0.69 \mathrm{~V}$ | $0 \times \mathrm{A} 9=0.85 \mathrm{~V}$ | $0 x C 9=1.01 \mathrm{~V}$ | $0 x E 9=1.17 \mathrm{~V}$ |
|  | $0 \times 8 \mathrm{~A}=0.695 \mathrm{~V}$ | $0 \times \mathrm{AA}=0.855 \mathrm{~V}$ | $0 \times C A=1.015 \mathrm{~V}$ | OxEA $=1.175 \mathrm{~V}$ |
|  | $0 \times 8 \mathrm{~B}=0.7 \mathrm{~V}$ | $0 \times \mathrm{AB}=0.86 \mathrm{~V}$ | $0 x C B=1.02 \mathrm{~V}$ | $0 \times E B=1.18 \mathrm{~V}$ |
|  | $0 \times 8 \mathrm{C}=0.705 \mathrm{~V}$ | $0 \times A C=0.865 \mathrm{~V}$ | $0 \times C C=1.025 \mathrm{~V}$ | OxEC $=1.185 \mathrm{~V}$ |
|  | $0 \times 8 \mathrm{D}=0.71 \mathrm{~V}$ | $0 \times A D=0.87 \mathrm{~V}$ | $0 x C D=1.03 \mathrm{~V}$ | $0 x E D=1.19 \mathrm{~V}$ |
|  | $0 \times 8 \mathrm{E}=0.715 \mathrm{~V}$ | 0xAE $=0.875 \mathrm{~V}$ | $0 x C E=1.035 \mathrm{~V}$ | OxEE $=1.195 \mathrm{~V}$ |
|  | $0 \times 8 \mathrm{~F}=0.72 \mathrm{~V}$ | $0 \times \mathrm{AF}=0.88 \mathrm{~V}$ | $0 x C F=1.04 \mathrm{~V}$ | $0 x E F=1.2 \mathrm{~V}$ |
|  | $0 \times 90=0.725 \mathrm{~V}$ | $0 \times \mathrm{B0}=0.885 \mathrm{~V}$ | $0 \times D 0=1.045 \mathrm{~V}$ | $0 x F 0=1.205 \mathrm{~V}$ |
|  | $0 \times 91=0.73 \mathrm{~V}$ | $0 \times \mathrm{B} 1=0.89 \mathrm{~V}$ | $0 x D 1=1.05 \mathrm{~V}$ | $0 x F 1=1.21 \mathrm{~V}$ |
|  | $0 \times 92=0.735 \mathrm{~V}$ | $0 \times \mathrm{B} 2=0.895 \mathrm{~V}$ | $0 \times \mathrm{D} 2=1.055 \mathrm{~V}$ | $0 \times F 2=1.215 \mathrm{~V}$ |
|  | $0 \times 93=0.74 \mathrm{~V}$ | $0 \times \mathrm{B} 3=0.9 \mathrm{~V}$ | $0 x D 3=1.06 \mathrm{~V}$ | $0 x F 3=1.22 \mathrm{~V}$ |
|  | $0 \times 94=0.745 \mathrm{~V}$ | $0 \times B 4=0.905 \mathrm{~V}$ | $0 \times D 4=1.065 \mathrm{~V}$ | $0 x F 4=1.225 \mathrm{~V}$ |
|  | $0 \times 95=0.75 \mathrm{~V}$ | $0 \times B 5=0.91 \mathrm{~V}$ | $0 x D 5=1.07 \mathrm{~V}$ | $0 x F 5=1.23 \mathrm{~V}$ |
|  | $0 \times 96=0.755 \mathrm{~V}$ | $0 \times B 6=0.915 \mathrm{~V}$ | $0 \times D 6=1.075 \mathrm{~V}$ | $0 x F 6=1.235 \mathrm{~V}$ |
| $0 \times 77=0.6 \mathrm{~V}$ | $0 \times 97=0.76 \mathrm{~V}$ | $0 \times B 7=0.92 \mathrm{~V}$ | $0 x D 7=1.08 \mathrm{~V}$ | $0 x F 7=1.24 \mathrm{~V}$ |
| $0 \times 78=0.605 \mathrm{~V}$ | $0 \times 98=0.765 \mathrm{~V}$ | $0 \times B 8=0.925 \mathrm{~V}$ | $0 \times D 8=1.085 \mathrm{~V}$ | $0 \times F 8=1.245 \mathrm{~V}$ |
| $0 \times 79=0.61 \mathrm{~V}$ | $0 \times 99=0.77 \mathrm{~V}$ | $0 \times \mathrm{B} 9=0.93 \mathrm{~V}$ | $0 x D 9=1.09 \mathrm{~V}$ | $0 \times F 9=1.25 \mathrm{~V}$ |
| $0 \times 7 \mathrm{~A}=0.615 \mathrm{~V}$ | $0 \times 9 \mathrm{~A}=0.775 \mathrm{~V}$ | $0 \times B A=0.935 \mathrm{~V}$ | $0 \times D A=1.095 \mathrm{~V}$ | $0 \times F A=1.255 \mathrm{~V}$ |
| $0 \times 7 \mathrm{~B}=0.62 \mathrm{~V}$ | $0 \times 9 \mathrm{~B}=0.78 \mathrm{~V}$ | $0 \times B B=0.94 \mathrm{~V}$ | $0 x D B=1.1 \mathrm{~V}$ | $0 \times F B=1.26 \mathrm{~V}$ |
| $0 \times 7 \mathrm{C}=0.625 \mathrm{~V}$ | $0 \times 9 \mathrm{C}=0.785 \mathrm{~V}$ | $0 \times B C=0.945 \mathrm{~V}$ | $0 \times D C=1.105 \mathrm{~V}$ | $0 x F C=1.265 \mathrm{~V}$ |
| $0 \times 7 \mathrm{D}=0.63 \mathrm{~V}$ | $0 \times 9 \mathrm{D}=0.79 \mathrm{~V}$ | $0 \times B D=0.95 \mathrm{~V}$ | $0 x D D=1.11 \mathrm{~V}$ | $0 x F D=1.27 \mathrm{~V}$ |
| $0 \times 7 \mathrm{E}=0.635 \mathrm{~V}$ | $0 \times 9 \mathrm{E}=0.795 \mathrm{~V}$ | $0 \times B E=0.955 \mathrm{~V}$ | $0 \times D E=1.115 \mathrm{~V}$ | $0 x F E=1.275 \mathrm{~V}$ |
| $0 \times 7 \mathrm{~F}=0.64 \mathrm{~V}$ | 0x9F $=0.8 \mathrm{~V}$ | $0 \times B F=0.96 \mathrm{~V}$ | $0 x D F=1.12 \mathrm{~V}$ | 0xFF $=1.28 \mathrm{~V}$ |

## REGISTER 7-3: VOUT: OUTPUT VOLTAGE CONTROL REGISTER (ADDRESS 0x02) (CONTINUED)

bit 7-0 Vo[7:0]: Output Voltage Control (SAYMP option)
For codes $0 \times 00$ to $0 \times 3 \mathrm{~B}$ : 0.6 V .

|  | $0 \times 40=0.65 \mathrm{~V}$ | $0 \times 60=0.97 \mathrm{~V}$ | $0 \times 80=1.3 \mathrm{~V}$ | $0 \times A 0=1.94 \mathrm{~V}$ | $0 \times C 0=2.58 \mathrm{~V}$ | OxE0 $=3.22 \mathrm{~V}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | $0 \times 41=0.66 \mathrm{~V}$ | $0 \times 61=0.98 \mathrm{~V}$ | $0 \times 81=1.32 \mathrm{~V}$ | $0 \times \mathrm{A} 1=1.96 \mathrm{~V}$ | $0 \times \mathrm{C} 1=2.6 \mathrm{~V}$ | $0 \times E 1=3.24 \mathrm{~V}$ |
|  | $0 \times 42=0.67 \mathrm{~V}$ | $0 \times 62=0.99 \mathrm{~V}$ | $0 \times 82=1.34 \mathrm{~V}$ | $0 \times \mathrm{A} 2=1.98 \mathrm{~V}$ | $0 \times \mathrm{C} 2=2.62 \mathrm{~V}$ | 0xE2 $=3.26 \mathrm{~V}$ |
|  | $0 \times 43=0.68 \mathrm{~V}$ | $0 \times 63=1 \mathrm{~V}$ | $0 \times 83=1.36 \mathrm{~V}$ | OxA3 $=2 \mathrm{~V}$ | $0 \times C 3=2.64 \mathrm{~V}$ | $0 \times E 3=3.28 \mathrm{~V}$ |
|  | $0 \times 44=0.69 \mathrm{~V}$ | $0 \times 64=1.01 \mathrm{~V}$ | $0 \times 84=1.38 \mathrm{~V}$ | $0 \times \mathrm{A} 4=2.02 \mathrm{~V}$ | $0 \mathrm{xC} 4=2.66 \mathrm{~V}$ | $0 x E 4=3.3 \mathrm{~V}$ |
|  | 0x45 $=0.7 \mathrm{~V}$ | $0 \times 65=1.02 \mathrm{~V}$ | 0x85 $=1.4 \mathrm{~V}$ | $0 \times A 5=2.04 \mathrm{~V}$ | $0 \times \mathrm{C} 5=2.68 \mathrm{~V}$ | 0xE5 $=3.32 \mathrm{~V}$ |
|  | $0 \times 46=0.71 \mathrm{~V}$ | $0 \times 66=1.03 \mathrm{~V}$ | $0 \times 86=1.42 \mathrm{~V}$ | $0 \times A 6=2.06 \mathrm{~V}$ | $0 \times C 6=2.7 \mathrm{~V}$ | $0 x E 6=3.34 \mathrm{~V}$ |
|  | $0 \times 47=0.72 \mathrm{~V}$ | $0 \times 67=1.04 \mathrm{~V}$ | $0 \times 87=1.44 \mathrm{~V}$ | $0 \times A 7=2.08 \mathrm{~V}$ | $0 \times C 7=2.72 \mathrm{~V}$ | $0 \times E 7=3.36 \mathrm{~V}$ |
|  | $0 \times 48=0.73 \mathrm{~V}$ | $0 \times 68=1.05 \mathrm{~V}$ | $0 \times 88=1.46 \mathrm{~V}$ | $0 \times \mathrm{A} 8=2.1 \mathrm{~V}$ | $0 \times \mathrm{C} 8=2.74 \mathrm{~V}$ | 0xE8 $=3.38 \mathrm{~V}$ |
|  | $0 \times 49=0.74 \mathrm{~V}$ | $0 \times 69=1.06 \mathrm{~V}$ | $0 \times 89=1.48 \mathrm{~V}$ | $0 \times \mathrm{A} 9=2.12 \mathrm{~V}$ | $0 \times \mathrm{C}=2.76 \mathrm{~V}$ | 0xE9 $=3.4 \mathrm{~V}$ |
|  | $0 \times 4 \mathrm{~A}=0.75 \mathrm{~V}$ | $0 \times 6 \mathrm{~A}=1.07 \mathrm{~V}$ | 0x8A $=1.5 \mathrm{~V}$ | $0 \times A A=2.14 \mathrm{~V}$ | $0 \times C A=2.78 \mathrm{~V}$ | 0xEA $=3.42 \mathrm{~V}$ |
|  | $0 \times 4 \mathrm{~B}=0.76 \mathrm{~V}$ | $0 \times 6 \mathrm{~B}=1.08 \mathrm{~V}$ | $0 \times 8 \mathrm{~B}=1.52 \mathrm{~V}$ | $0 \times A B=2.16 \mathrm{~V}$ | $0 \times \mathrm{CB}=2.8 \mathrm{~V}$ | $0 \times E B=3.44 \mathrm{~V}$ |
|  | $0 \times 4 \mathrm{C}=0.77 \mathrm{~V}$ | $0 \times 6 \mathrm{C}=1.09 \mathrm{~V}$ | $0 \times 8 \mathrm{C}=1.54 \mathrm{~V}$ | $0 \times A C=2.18 \mathrm{~V}$ | OxCC $=2.82 \mathrm{~V}$ | OxEC $=3.46 \mathrm{~V}$ |
|  | $0 \times 4 \mathrm{D}=0.78 \mathrm{~V}$ | $0 \times 6 \mathrm{D}=1.1 \mathrm{~V}$ | $0 \times 8 \mathrm{D}=1.56 \mathrm{~V}$ | OxAD $=2.2 \mathrm{~V}$ | $0 \times C D=2.84 \mathrm{~V}$ | 0xED $=3.48 \mathrm{~V}$ |
|  | $0 \times 4 \mathrm{E}=0.79 \mathrm{~V}$ | $0 \times 6 \mathrm{E}=1.11 \mathrm{~V}$ | $0 \times 8 \mathrm{E}=1.58 \mathrm{~V}$ | $0 \times \mathrm{AE}=2.22 \mathrm{~V}$ | OxCE $=2.86 \mathrm{~V}$ | 0xEE $=3.5 \mathrm{~V}$ |
|  | $0 \times 4 \mathrm{~F}=0.8 \mathrm{~V}$ | $0 \times 6 \mathrm{~F}=1.12 \mathrm{~V}$ | 0x8F $=1.6 \mathrm{~V}$ | $0 \times \mathrm{AF}=2.24 \mathrm{~V}$ | $0 \times C F=2.88 \mathrm{~V}$ | OxEF $=3.52 \mathrm{~V}$ |
|  | $0 \times 50=0.81 \mathrm{~V}$ | $0 \times 70=1.13 \mathrm{~V}$ | $0 \times 90=1.62 \mathrm{~V}$ | $0 \times B 0=2.26 \mathrm{~V}$ | 0xD0 $=2.9 \mathrm{~V}$ | $0 \times F 0=3.54 \mathrm{~V}$ |
|  | $0 \times 51=0.82 \mathrm{~V}$ | $0 \times 71=1.14 \mathrm{~V}$ | $0 \times 91=1.64 \mathrm{~V}$ | $0 \times B 1=2.28 \mathrm{~V}$ | $0 \times \mathrm{D} 1=2.92 \mathrm{~V}$ | $0 \times F 1=3.56 \mathrm{~V}$ |
|  | $0 \times 52=0.83 \mathrm{~V}$ | $0 \times 72=1.15 \mathrm{~V}$ | $0 \times 92=1.66 \mathrm{~V}$ | $0 \times \mathrm{B} 2=2.3 \mathrm{~V}$ | $0 \times \mathrm{D} 2=2.94 \mathrm{~V}$ | $0 \times F 2=3.58 \mathrm{~V}$ |
|  | $0 \times 53=0.84 \mathrm{~V}$ | $0 \times 73=1.16 \mathrm{~V}$ | $0 \times 93=1.68 \mathrm{~V}$ | $0 \times B 3=2.32 \mathrm{~V}$ | 0xD3 $=2.96 \mathrm{~V}$ | $0 \mathrm{xF} 3=3.6 \mathrm{~V}$ |
|  | $0 \times 54=0.85 \mathrm{~V}$ | $0 \times 74=1.17 \mathrm{~V}$ | $0 \times 94=1.7 \mathrm{~V}$ | $0 \times B 4=2.34 \mathrm{~V}$ | $0 \times \mathrm{LD} 4=2.98 \mathrm{~V}$ | $0 \times F 4=3.62 \mathrm{~V}$ |
|  | $0 \times 55=0.86 \mathrm{~V}$ | $0 \times 75=1.18 \mathrm{~V}$ | $0 \times 95=1.72 \mathrm{~V}$ | $0 \times B 5=2.36 \mathrm{~V}$ | 0xD5 = 3V | 0xF5 = 3.64V |
|  | $0 \times 56=0.87 \mathrm{~V}$ | $0 \times 76=1.19 \mathrm{~V}$ | $0 \times 96=1.74 \mathrm{~V}$ | $0 \times B 6=2.38 \mathrm{~V}$ | $0 \times \mathrm{D} 6=3.02 \mathrm{~V}$ | 0xF6 $=3.66 \mathrm{~V}$ |
|  | $0 \times 57=0.88 \mathrm{~V}$ | $0 \times 77=1.2 \mathrm{~V}$ | $0 \times 97=1.76 \mathrm{~V}$ | $0 \times \mathrm{B7}=2.4 \mathrm{~V}$ | $0 \times D 7=3.04 \mathrm{~V}$ | $0 \times F 7=3.68 \mathrm{~V}$ |
|  | $0 \times 58=0.89 \mathrm{~V}$ | $0 \times 78=1.21 \mathrm{~V}$ | $0 \times 98=1.78 \mathrm{~V}$ | $0 \times B 8=2.42 \mathrm{~V}$ | 0xD8 $=3.06 \mathrm{~V}$ | $0 \mathrm{xF8}=3.7 \mathrm{~V}$ |
|  | $0 \times 59=0.9 \mathrm{~V}$ | $0 \times 79=1.22 \mathrm{~V}$ | $0 \times 99=1.8 \mathrm{~V}$ | $0 \times B 9=2.44 \mathrm{~V}$ | 0xD9 $=3.08 \mathrm{~V}$ | 0xF9 $=3.72 \mathrm{~V}$ |
|  | $0 \times 5 \mathrm{~A}=0.91 \mathrm{~V}$ | $0 \times 7 \mathrm{~A}=1.23 \mathrm{~V}$ | $0 \times 9 \mathrm{~A}=1.82 \mathrm{~V}$ | $0 \times B A=2.46 \mathrm{~V}$ | $0 x D A=3.1 \mathrm{~V}$ | $0 \times F A=3.74 \mathrm{~V}$ |
| 0x3B $=0.6 \mathrm{~V}$ | $0 \times 5 \mathrm{~B}=0.92 \mathrm{~V}$ | $0 \times 7 \mathrm{~B}=1.24 \mathrm{~V}$ | $0 \times 9 \mathrm{~B}=1.84 \mathrm{~V}$ | $0 \times B B=2.48 \mathrm{~V}$ | $0 \times D B=3.12 \mathrm{~V}$ | $0 \times F B=3.76 \mathrm{~V}$ |
| $0 \times 3 \mathrm{C}=0.61 \mathrm{~V}$ | $0 \times 5 \mathrm{C}=0.93 \mathrm{~V}$ | $0 \times 7 \mathrm{C}=1.25 \mathrm{~V}$ | $0 \times 9 \mathrm{C}=1.86 \mathrm{~V}$ | $0 \times B C=2.5 \mathrm{~V}$ | $0 \times D C=3.14 \mathrm{~V}$ | $0 \times F C=3.78 \mathrm{~V}$ |
| $0 \times 3 \mathrm{D}=0.62 \mathrm{~V}$ | $0 \times 5 \mathrm{D}=0.94 \mathrm{~V}$ | $0 \times 7 \mathrm{D}=1.26 \mathrm{~V}$ | $0 \times 9 \mathrm{D}=1.88 \mathrm{~V}$ | $0 \times B D=2.52 \mathrm{~V}$ | OxDD $=3.16 \mathrm{~V}$ | 0xFD $=3.8 \mathrm{~V}$ |
| $0 \times 3 \mathrm{E}=0.63 \mathrm{~V}$ | $0 \times 5 \mathrm{E}=0.95 \mathrm{~V}$ | $0 \times 7 \mathrm{E}=1.27 \mathrm{~V}$ | 0x9E $=1.9 \mathrm{~V}$ | $0 \times B E=2.54 \mathrm{~V}$ | 0xDE $=3.18 \mathrm{~V}$ | 0xFE $=3.82 \mathrm{~V}$ |
| $0 \times 3 \mathrm{~F}=0.64 \mathrm{~V}$ | $0 \times 5 \mathrm{~F}=0.96 \mathrm{~V}$ | $0 \times 7 \mathrm{~F}=1.28 \mathrm{~V}$ | $0 \mathrm{x9F}=1.92 \mathrm{~V}$ | $0 \times B F=2.56 \mathrm{~V}$ | OxDF $=3.2 \mathrm{~V}$ | 0xFF $=3.84 \mathrm{~V}$ |

## REGISTER 7-4: FAULT: STATUS AND FAULT REGISTER (ADDRESS 0x03)

| R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 | R-0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OT_WARN | EN_STAT | BOOT_ERR | SSD | HICCUP | OT | LATCH_OFF | PG |
| bit 7 |  |  |  | bit 0 |  |  |  |

Legend:

| $R=$ Readable bit | $W=$ Writable bit | $U=$ Unimplemented bit, read as ' 0 ' |
| :--- | :--- | :--- |
| $-n=$ Value at POR | $' 1 '=$ Bit is set | $' 0 '=$ Bit is cleared |

bit $7 \quad$ OT_WARN: Overtemperature Warning
$0=$ No Fault
1 = Fault
bit 6 EN_STAT: Buck On/Off Control

$$
0=\text { Off }
$$

1 = On
bit 5 BOOT_ERR: Boot-up Error
$0=$ No Fault
1 = Fault
bit 4 SSD: Soft Start Done
0 = Ramp not done
1 = Ramp done
bit 3 HICCUP: Current Limit Hiccup
$0=$ Not in Hiccup mode
1 = In Hiccup mode
bit 2
OT: Overtemperature
$0=$ No Fault
1 = Fault
bit 1 LATCH_OFF: Overcurrent or Overtemperature Fault Latch-Off
$0=$ No Fault
1 = Fault (device is latched off)
bit 0
PG: Power Good
0 = Power not good
1 = Power good

## MIC33M656

NOTES:

### 8.0 PACKAGING INFORMATION

### 8.1 Package Marking Information

53-Lead B1QFN


Example


Legend: $X X$...X Customer-specific information
$Y \quad$ Year code (last digit of calendar year)
YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')
NNN Alphanumeric traceability code
(e3) Pb-free JEDEC designator for Matte Tin (Sn)

* This package is Pb -free. The Pb -free JEDEC designator (e3)
can be found on the outer packaging for this package.
Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.


## MIC33M656

## 53-Lead Very Thick Plastic Quad Flat, No Lead Package (QDA) - 6x10x3.05 mm Body [B1QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging


Microchip Technology Drawing C04-1272 Rev B Sheet 1 of 2

## 53-Lead Very Thick Plastic Quad Flat, No Lead Package (QDA) - 6x10x3.05 mm Body [B1QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging


| Units |  | MILLIMETERS |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Dimension Limits |  | MIN | NOM | MAX |
| Number of Terminals | N | 53 |  |  |
| Pitch | e | 0.50 BSC |  |  |
| Overall Height | A | 2.95 | 3.00 | 3.05 |
| Standoff | A1 | 0.00 | 0.02 | 0.05 |
| Terminal Thickness | A3 | 0.203 REF |  |  |
| Overall Length | D | 6.00 BSC |  |  |
| Exposed Pad Length | D2 | 1.225 | 1.275 | 1.325 |
| Exposed Pad Length | D3 | 0.60 | 0.65 | 0.70 |
| Exposed Pad Length | D4 | 0.55 | 0.60 | 0.65 |
| Overall Width | E | 10.00 BSC |  |  |
| Exposed Pad Width | E2 | 4.475 | 4.525 | 4.575 |
| Exposed Pad Width | E3 | 1.575 | 1.625 | 1.675 |
| Exposed Pad Width | E4 | 0.45 | 0.50 | 0.55 |
| Exposed Pad Width | E5 | 0.60 | 0.65 | 0.70 |
| Exposed Pad Width | E6 | 6.573 | 6.623 | 6.673 |
| Package Edge to Exposed Pad | K1 | 0.85 | 0.90 | 0.95 |
| Package Edge to Exposed Pad | K2 | 0.85 | 0.90 | 0.95 |
| Exposed Pad to Exposed Pad | K3 | 1.90 | 1.95 | 2.00 |
| Exposed Pad to Exposed Pad | K4 | 0.45 | 0.50 | 0.55 |
| Exposed Pad to Exposed Pad | K5 | 0.45 | 0.50 | 0.55 |
| Exposed Pad to Exposed Pad | K6 | 0.45 | 0.50 | 0.55 |
| Terminal Width | b | 0.20 | 0.25 | 0.30 |
| Terminal Length | L | 0.45 | 0.50 | 0.55 |

Notes:
Terminal Length

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated
3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

## MIC33M656

## 53-Lead Very Thick Plastic Quad Flat, No Lead Package (QDA) - 6x10x3.05 mm Body [B1QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging


Microchip Technology Drawing C04-3272 Rev B Sheet 1 of 2

## 53-Lead Very Thick Plastic Quad Flat, No Lead Package (QDA) - 6x10x3.05 mm Body [B1QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

## RECOMMENDED LAND PATTERN

| Units |  | MILLIMETERS |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Dimension Limits |  | MIN | NOM | MAX |
| Contact Pitch | E | 0.50 BSC |  |  |
| Contact Pad Spacing | C1 |  | 5.68 |  |
| Contact Pad Spacing | C2 |  | 9.68 |  |
| Contact Pad Width (X53) | X1 |  |  | 0.30 |
| Contact Pad Length (X53) | Y1 |  |  | 1.02 |
| Center Pad Width | X2 |  |  | 0.65 |
| Center Pad Length | Y2 |  |  | 1.68 |
| Center Pad Width (X4) | X3 |  |  | 1.33 |
| Center Pad Length (X2) | Y3 |  |  | 4.58 |
| Center Pad Width | X4 |  |  | 0.70 |
| Center Pad Length | Y4 |  |  | 6.62 |
| Center Pad Length | Y5 |  |  | 0.70 |
| Center Pad Length | Y6 |  |  | 0.55 |
| Contact Pad to Center Pad (X2) | G1 | 0.45 |  |  |
| Contact Pad to Contact Pad (X48) | G2 | 0.20 |  |  |
| Contact Pad to Center Pad | G3 | 0.45 |  |  |
| Contact Pad to Center Pad | G4 | 0.45 |  |  |
| Contact Pad to Center Pad | G5 | 0.20 |  |  |
| Contact Pad to Center Pad | G6 | 0.20 |  |  |
| Contact Pad to Center Pad | G7 | 0.30 |  |  |
| Thermal Via Diameter | V |  | 0.33 |  |
| Thermal Via Pitch (X12) | EV |  | 1.20 |  |

## Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
2. For best soldering results, thermal vias, if used, should be filled or tented to avoid solder loss during reflow process
3. Thermal vias are centered within each exposed pad.

## MIC33M656

NOTES:

## APPENDIX A: REVISION HISTORY

Revision A (September 2019)

- Initial release of this Data Sheet.


## MIC33M656

NOTES:

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

| PART NO. <br> Device |  | Examples: <br> a) MIC33M656-FAYMP-TR: 0.9 V Output, $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ Temperature Range, 53-Lead B1QFN Package, Tape and Reel |
| :---: | :---: | :---: |
| Device: | MIC33M656: 6A, Power Module Buck Converter with HyperLight Load ${ }^{\circledR}$ and $I^{2} \mathrm{C}$ Interface | b) MIC33M656-HAYMP-TR: 1.0 V Output, $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ Temperature Range, 53-Lead B1QFN Package, Tape and Reel |
| Output Voltage Option: | $\begin{aligned} & \mathrm{FA}=0.9 \mathrm{~V} \\ & \mathrm{HA}=1.0 \mathrm{~V} \\ & \mathrm{SA}=1.0 \mathrm{~V} \text {, with } 10 \mathrm{mV} \text { or } 20 \mathrm{mV} \text { resolution } \end{aligned}$ | c) MIC33M656-SAYMP-TR: 1.0 V Output, $-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ Temperature Range, 53-Lead B1QFN Package, Tape and Reel |
| Junction <br> Temperature Range: | $Y=-40^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ |  |
| Package: <br> Tape and Reel Option: | ```MP = 53 Lead 6 mm x 10 mm x 3 mm Very Thick Plastic Quad Flat, No Lead (B1QFN) TR = Tape and Reel(1)``` | Note 1: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with Microchip for package availability with the Tape and Reel option. |

## MIC33M656

NOTES:

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